





Enabling U.S. Solar Manufacturing: Laplace N-Type High-Efficiency Cell Solutions

Speaker:

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RE+ - TaiyangNews – EUPD Research

SOLAR – MADE IN THE USA Conference

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LAPLACE Renewable Energy Technology Co., Ltd.

IP (Innovation for TOPCon):

Market protection

- Strong U.S. demand driven by IRA incentives and FEOC compliance rules
- Barriers to imports create clear opportunity for local manufacturing
- Laplace supports U.S. customers with proven turnkey solutions



- Robust IP portfolio and FTO (Freedom-to-Operate) analysis
- Customers protected from infringement risks
- Continuous monitoring of patent landscape for added security

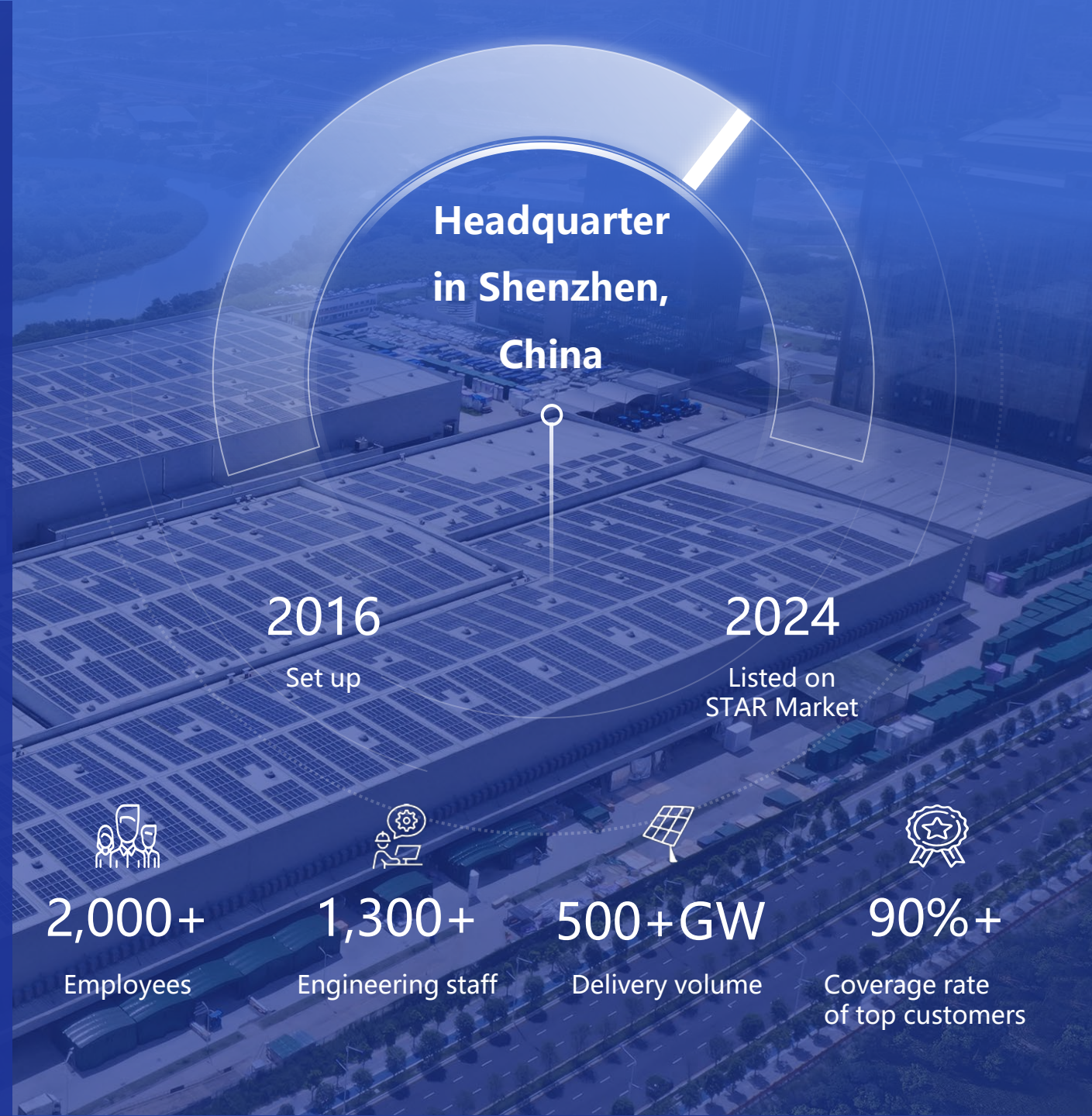
Technology: Leading equipment for TOPCon+ and XBC

- Proprietary TOPCon+ and XBC process equipment delivering >25% efficiency cells
- Reduced tool count and optimized fab layout for lower CAPEX/OPEX
- Proven global deployments in Turkey, Europe, and upcoming U.S. projects

WHO IS LAPLACE ?

Multiple Breakthroughs in Solar Innovation:

- Pioneer of TOPCon for mass production
- Vanguard of TOPCon+
- Innovator of Back Contact (BC) with almost 100% market share
- New deposition platform for perovskite-based tandem



PROJECT EXPERIENCE

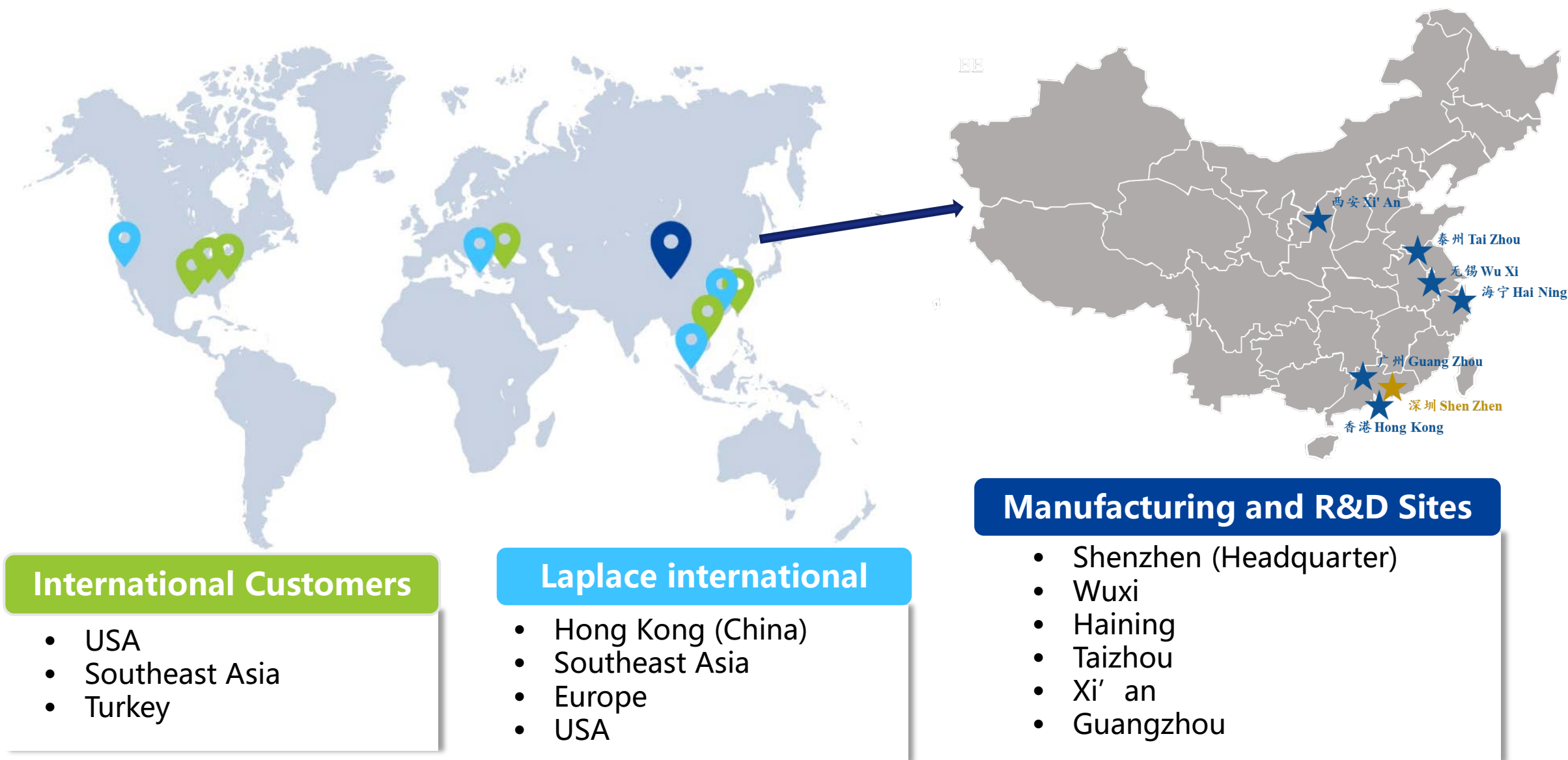


- >500 GW of TOPCon/P-IBC/N-IBC/PERC equipment delivered (CNY ~ 17 BN, USD ~ 2.4 BN)
- >20GW outside of China from USA, Southeast Asia, and Turkey
- Biggest project: 30GW
- 800+ people in support: extensive experience in manufacturing of TOPCon & BC technology with cutting-edge performance and IP



CUSTOMER RECOGNITION (SELECTED LIST)





International Customers

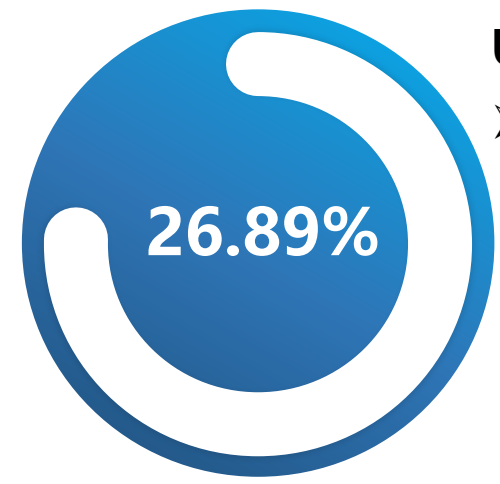
- USA
- Southeast Asia
- Turkey

Laplace international

- Hong Kong (China)
- Southeast Asia
- Europe
- USA

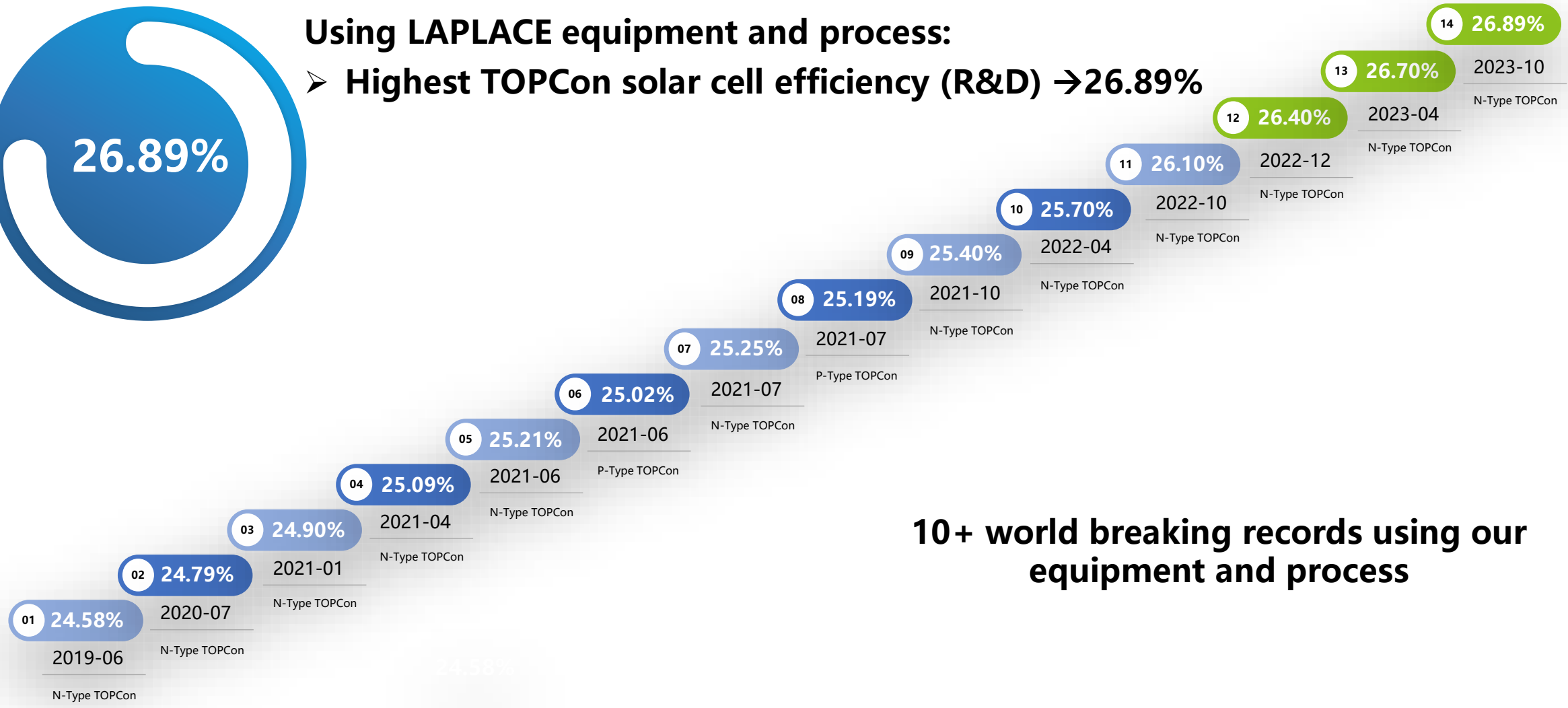
Manufacturing and R&D Sites

- Shenzhen (Headquarter)
- Wuxi
- Haining
- Taizhou
- Xi'an
- Guangzhou

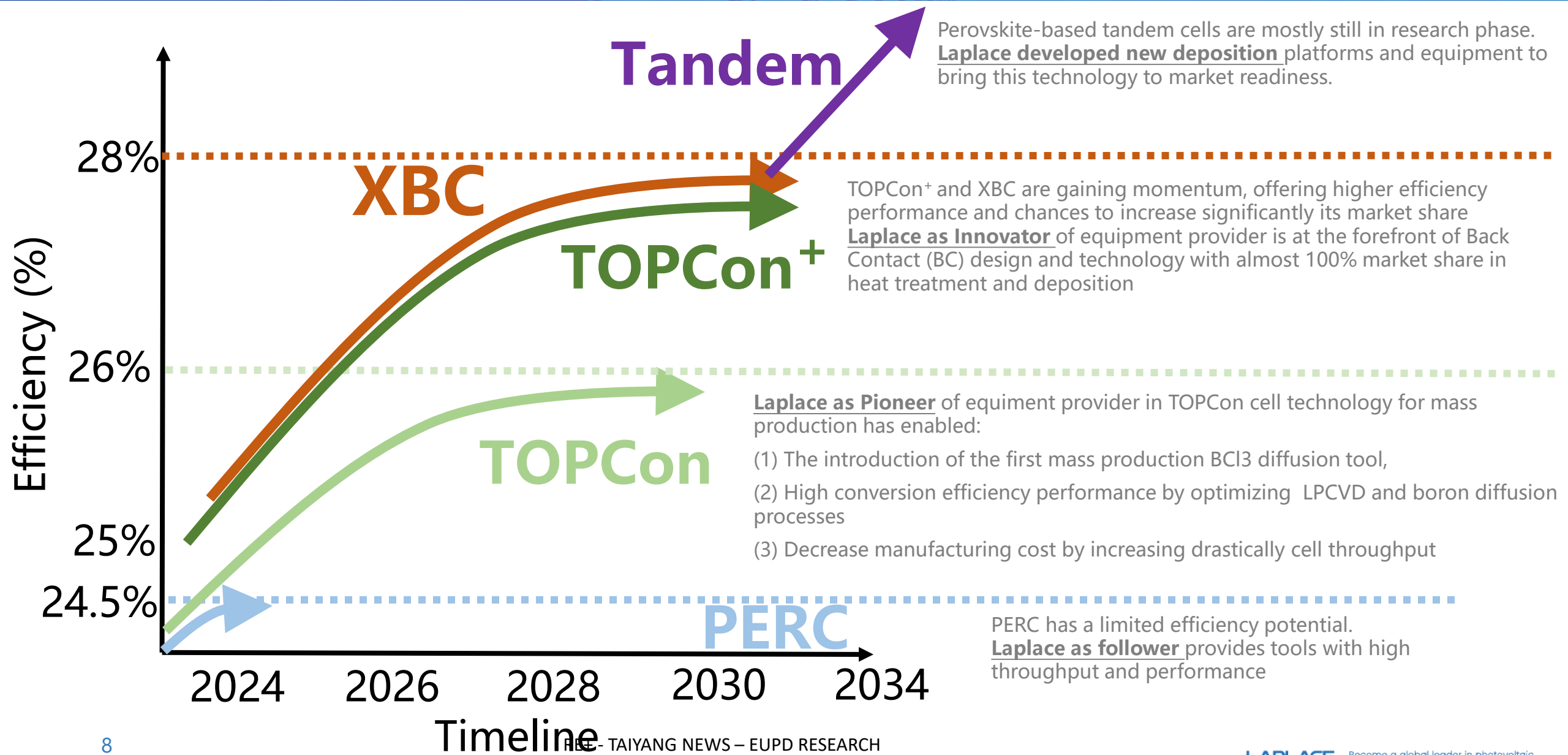


Using LAPLACE equipment and process:

➤ Highest TOPCon solar cell efficiency (R&D) →26.89%

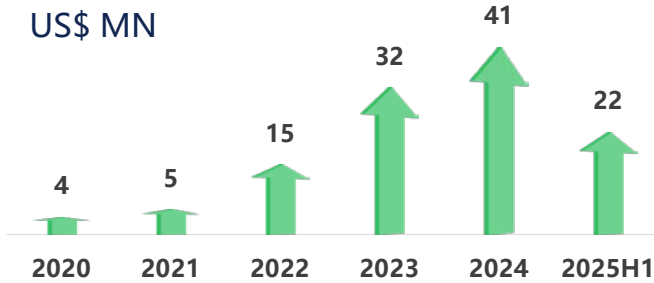


10+ world breaking records using our equipment and process



R&D Investment

Unit:
US\$ MN



120+
Million US\$
Cumulative R&D expenditure

01

Pioneering transition from BBr_3 to BCl_3

- > 70% cost reduction

02

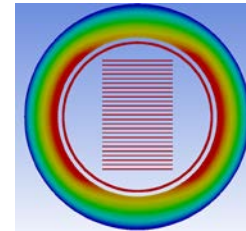
Double-loading (back- to-back wafers)

- Diffusion, Oxidation and LPCVD
- Doubled throughput without need of change in process flow
- Highest throughput for LPCVD, much lower CoO in comparison with PECVD

03

In-House Heating elements

- Improved thermal uniformity, shorter processing time
- Longer quartz parts lifetime



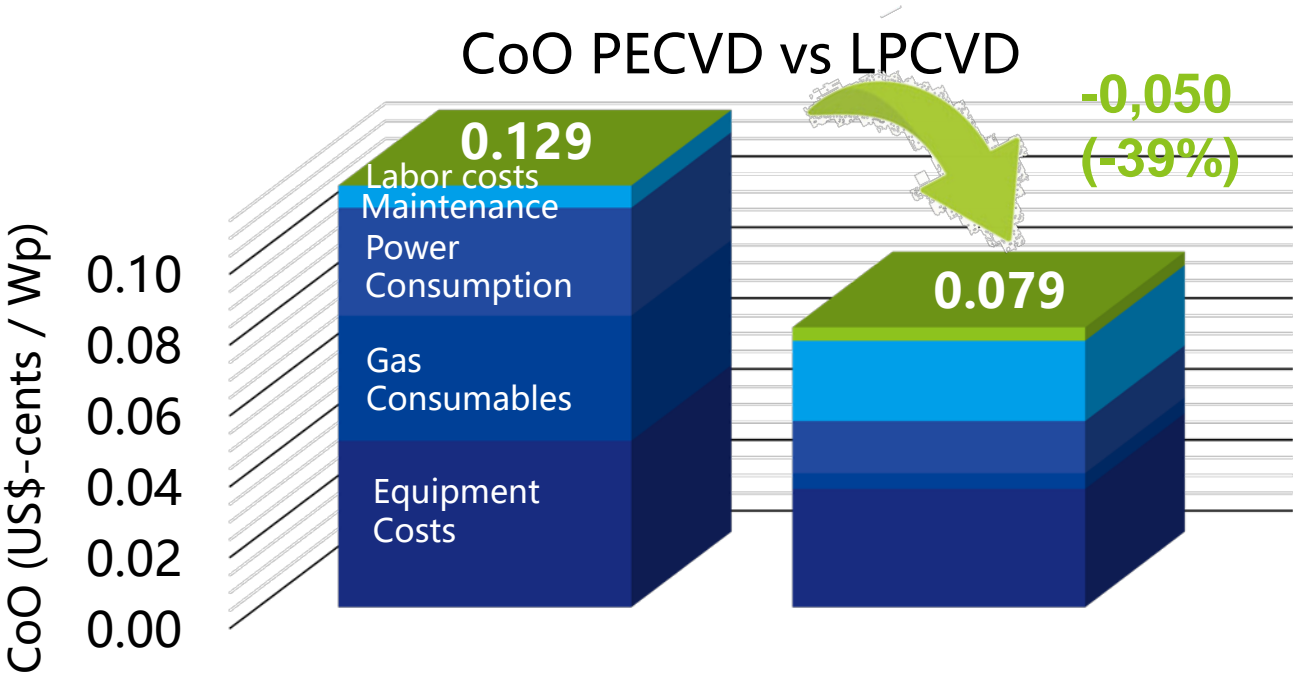
04

Quartz tube inside coating

- Pre-coating by nano crystallization technology
- Tube lifetime increase to over 6-9 months

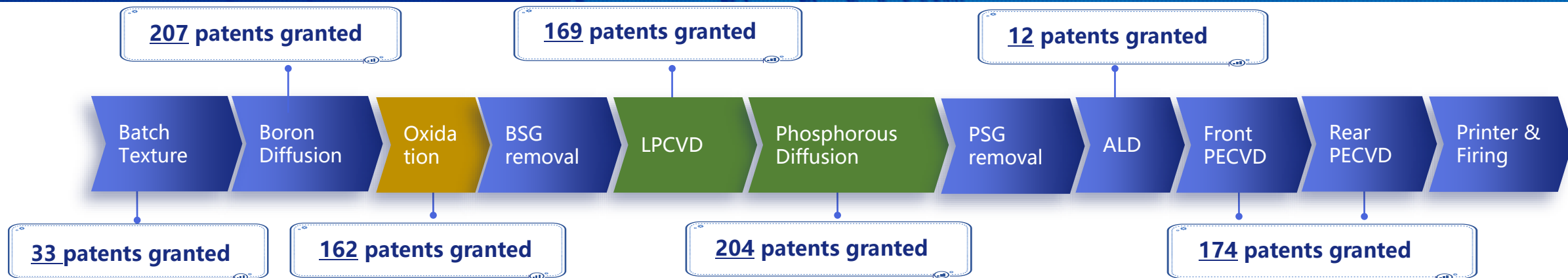


- **Laplace has improved the tool efficiency:**
For M10 wafers, besides double loading, GEN 4 Laplace tools have 2400 wafers/tube while GEN 5 has 2880 wafers/tube
- **Quartz tube inside coating:**
Pre-coating by nano crystallization technology increased tube lifetime to over 6-9 months



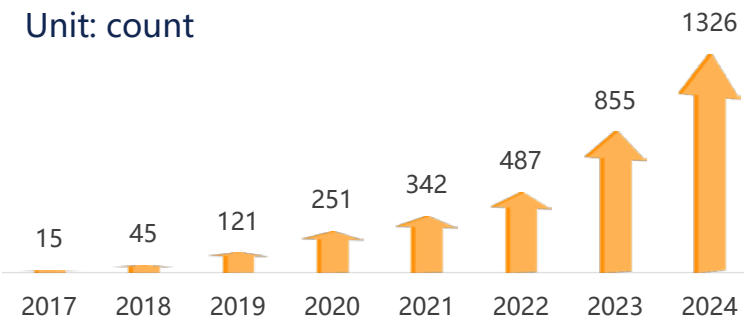
GEN5 tools (double loading) combined with increased tube lifetime have improved significantly the CoO of LPCVD with today a **~40% lower CoO than PECVD**.

LAPLACE Equipment Patent Portfolio



Accumulated Patent Applications

Unit: count



1,300+
Applied Patents

700+
Granted patents

- Laplace has a strong patent portfolio and is protecting its customers
- Laplace continuously analyses upcoming patents and lawsuits to ensure a seamless adaptation of upcoming technologies.

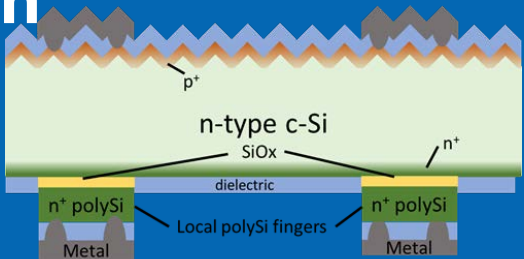
Laplace proprietary **TOPCon process flow**, and **LPCVD with ex-situ doping** technology allows customers to manufacture and sell TOPCon products to the USA and Europe



Why TOPCon+ and BC Technologies are taking over TOPCon

TOPCon

TOPCon+

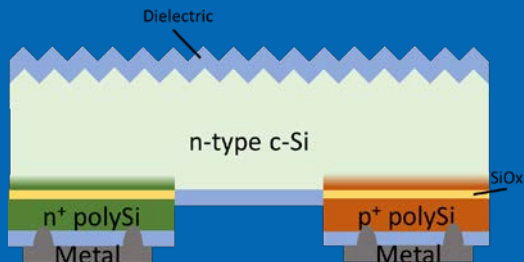


Eff. up to 27.62 % [1]

Similar requirements

- Stable, uniform, thermal SiOx
- Lasers gain importance

XBC



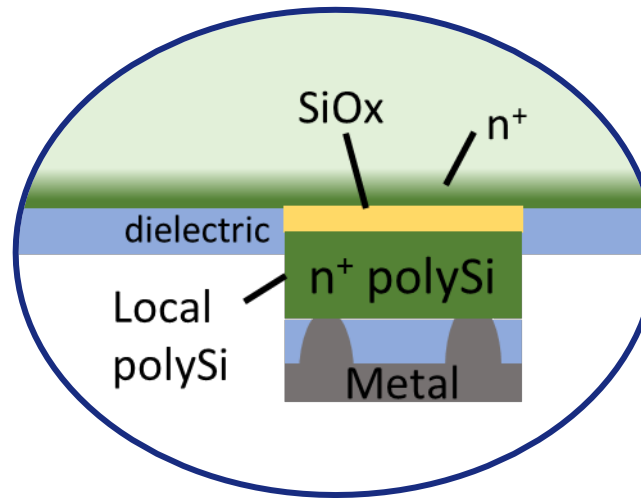
Eff. up to 27.99 % [1]

	TOPCon+	TOPCon	Back Contact
Bifaciality:	85 %	80 %	70 %
Manufacturing Complexity weighted score	7 (moderate)	6 (moderate)	10 (hard)
Required manpower:	103 %	100 %	120%

Why LAPLACE has a leading role for TOPCon⁺ and XBC Technology

Most important demand for all TOPCon plus and XBC cells:
Stable, reproducible, uniform, thermal SiOx layer

——> Implementation to TOPCon plus and XBC requires the use of **LPCVD for the deposition of both the tunnel SiOx and polysilicon layers**



For localized polySi, either as polySi fingers or XBC design, lasers are the most cost-efficient way for patterning

Laplace developed advanced laser technology for all critical steps in TOPCon plus and XBC manufacturing

Our Turnkey technology is **fully compatible** for the polySi implementation in TOPCon⁺ and XBC cells, with equipment already delivered and operating successfully.



LAPLACE Equipment Portfolio for TOPCon Cell Line



Heat treatment

Solid State diffusion and Oxidation

Boron Diffusion

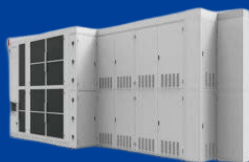
- Pioneering BCl₃
- 5TH GENERATION
- > 1,000 machines delivered
- Rank first by market share

Oxidation & Annealing

- 5TH GENERATION
- > 700 machines delivered
- coating film.

Phosphorous Diffusion

- 5TH GENERATION
- > 400 machines delivered
- Larger production capacity, and can reduce costs



Deposition

LPCVD

- 5TH GENERATION
- > 1,300 machines delivered
- Rank first by market share

ALD

- 2ND GENERATION
- Double-layer sealing ensures the uniformity of the coating film.

PECVD

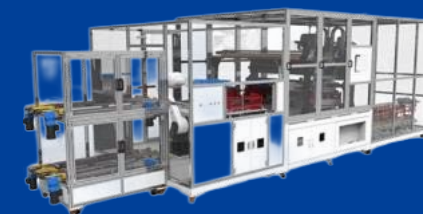
- 5TH GENERATION
- > 600 machines delivered
- Larger production capacity, and can reduce costs



Automation

Loading, transfer, up to full automation for entire cell line

- > 2,000 machines delivered





New Laplace Tools For TOPCon+ and Back Contact

Atomic Edge Passivation Deposition Complete Solution (EPD)

Function:

Mechanism:

Cut wafers in half and passivate to edges to recover the losses
Non-destructive laser is used to separate the wafer in two pieces. Half cells are stacked to a coin-stack and a passivation layer is deposited on the edges.

Dimensions:

Throughput:

19,04 x 4,60 x 3,70 m

10000 pcs/h (M10)



Poly Thickness Removal via Laser Ablation

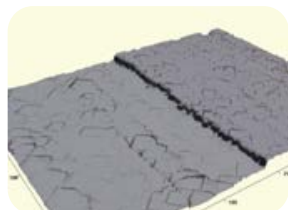
Function: Reduce parasitic absorption, increase conversion efficiency and bifaciality factor

Mechanism: Remove poly-silicon locally

Dimensions: 5,56 x 4,00 x 2,80 m

Throughput: 9000 pcs/h (M10)

3D morphology
of etching edge



XBC Cell Laser Contact Opening

Function:

Structure doped layer pattern

Mechanism:

Remove local layer by ultrafast laser

Throughput:

≥ 3600 pcs/h (M10)

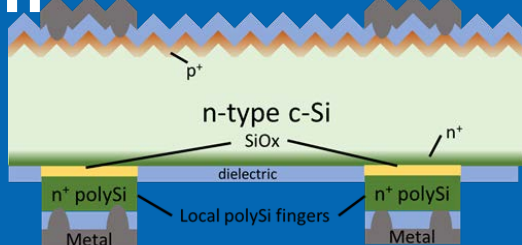




What is Next:

TOPCon

TOPCon⁺

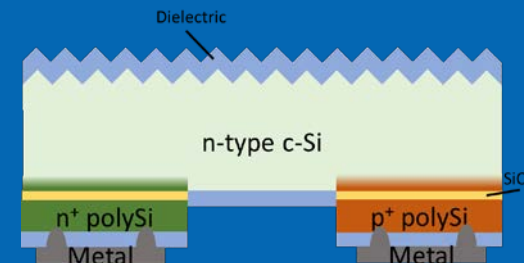


Eff. up to 27.62 % [1]

Similar requirements

- Stable, uniform, thermal SiOx
- Lasers gain importance

XBC



Eff. up to 27.99 % [1]

Tandem

- Perovskite-based tandem cells are mostly still in research phase
- Laplace has developed new platforms and equipment that are currently in pilot lines
- Laplace ready to enter the US market with our new Perovskite platform



COME SEE US

Innovation. Protection. U.S. Solar

LAPLACE BOOTH V7720



From:

LAPLACE



To:

RE+Vegas

Date:

September 09-11

Booth:

V7720

Venue:

201 Sands Avenue Las Vegas, NV 89169

A Global Leader in N-type High-efficiency
Solar Cell Manufacturing Solutions



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